

# ALD110800/ALD110900/ ALD1108XX/ALD1109XX/ALD1148XX/ALD1149XX

## PERFORMANCE CHARACTERISTICS OF EPAD® MATCHED PAIR MOSFET ARRAYS

#### **GENERAL DESCRIPTION**

ALD1108xx/ALD1109xx/ALD1148xx/ALD1149xx are monolithic quad/dual N-Channel MOSFETs matched at the factory using ALD's proven EPAD® CMOS technology. These devices are intended for low voltage, small signal applications.

This EPAD MOSFET Array product family (EPAD MOSFET) is available in the three separate categories, each providing a distinctly different set of device electrical specifications and characteristics. The first category is the ALD110800/ALD110900 zero-threshold mode EPAD MOSFETs. The second category is the ALD1108xx/ALD1109xx enhancement mode EPAD MOSFETs. The third category is the ALD1148xx/ALD1149xx depletion mode EPAD MOSFETs. (The suffix "xx" denotes threshold voltage in 0.0 V steps, for example, xx=08 denotes 0.8V).

The ALD110800/ALD110900 (quad/dual) are EPAD MOSFETs in which the individual threshold voltage of each MOSFET is fixed at zero. The threshold voltage is defined as Ids =1uA @ Vds=0.1V when the gate voltage Vgs = 0.0V. Zero threshold devices operate in the enhancement region when operated above threshold voltage and current level (Vgs>0.0V and Ids>1 uA) and subthreshold region when operated at or below threshold voltage and current level (Vgs<=0.0V and Ids<1 uA). This device, along with other very low threshold voltage members of the product family, constitute a class of EPAD MOSFETs that enable ultra low supply voltage operation and nanopower type of circuit designs, applicable in either analog or digital circuits.

The ALD1108xx/ALD1109xx (quad/dual) product family features precision matched enhancement mode EPAD MOSFET devices, which require a positive bias voltage to turn on. Precision threshold values such as +1.40V, +0.80V, +0.20V are offered. No conductive channel exists between the source and drain at zero applied gate voltage for these devices, except that the +0.20V version has a subthreshold current at about 20 nA.

The ALD1148xx/ALD1149xx (quad/dual) features depletion mode EPAD MOSFETs, which are normally-on devices when the gate bias voltage is at zero volt. The depletion mode threshold voltage is at a negative voltage level at which the EPAD MOSFET turns off. Without a supply voltage and/ or with Vg=0.0V the EPAD MOSFET device is already turned on and exhibits a defined and controlled on-resistance between the source and drain terminals.

The ALD1148xx/ALD1149xx depletion mode EPAD MOSFETs are different from most other types of depletion mode MOSFETs and certain types of JFETs in that they do not exhibit high gate leakage currents and channel/ junction leakage currents. When negative signal voltages are applied to the gate terminal, the designer/user can depend on the EPAD MOSFET device to be controlled, modulated and turned off precisely. The device can be modulated and turned-off under the control of the gate voltage in the same manner as the enhancement mode EPAD MOSFET and the same device equations apply.

EPAD MOSFETs are designed for exceptional device electrical characteristics matching. As these devices are on the same monolithic chip, they also exhibit excellent tempco tracking characteristics. Besides matched pair electrical characteristics, each individual EPAD MOSFET also exhibits tightly controlled parameters, enabling the user to depend on design limits. Even units from different batches have well matched characteristics.

EPAD MOSFETs are ideal for minimum offset voltage and differential thermal response, and they are used for switching and amplifying applications in low voltage (1V to 10V or +/-0.5V to +/-5V) or ultra low voltage (less than 1V or +/ - 0.5V) systems. They feature low input bias current (less than 30 pA max.), ultra low power (microWatt) or Nanopower (power measured in nanoWatt) operation, low input capacitance and fast switching speed. These devices can be used

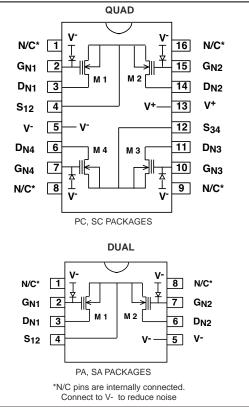
#### **KEY APPLICATION ENVIRONMENT**

EPAD( MOSFET Array products are for circuit applications in one or more of the following operating environments:

where a combination of these characteristics are desired.

- \* Low voltage: 1V to 10V or +/- 0.5V to +/- 5V
- \* Ultra low voltage: less than 1V or +/- 0.5V
- \* Low power: voltage x current = power measured in microwatt
- \* Nanopower: voltage x current = power measured in nanowatt

\* Precision matching and tracking of two or more of the MOSFETs



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#### **ELECTRICAL CHARACTERISTICS**

The turn-on and turn-off electrical characteristics of the EPAD MOSFET products are shown in the Drain-Source On Current vs Drain-Source On Voltage and Drain-Source On Current vs Gate-Source Voltage graphs. Each graph show the Drain-Source On Current versus Drain-Source On Voltage characteristics as a function of Gate-Source voltage in a different operating region under different bias conditions. As the threshold voltage is tightly specified, the Drain-Source On Current at a given gate input voltage is better controlled and more predictable when compared to many other types of MOSFETs.

EPAD MOSFETs behave similarly to a standard MOSFET, therefore classic equations for a n-channel MOSFET applies to EPAD MOSFET as well. The Drain current in the linear region (Vds < Vgs - Vth ) is given by:

Id = u .Cox . W/L . [Vgs - Vgs(th) - Vds/2] . Vds

where

u is the mobility Cox is capacitance per unit area of Gate electrode Vgs is the Gate to Source voltage Vgs(th) is the turn-on threshold voltage Vds is the Drain to Source voltage W is the channel width and L is the channel length

In this region of operation the lds value is proportional to Vds value and the device can be used as gate-voltage controlled resistor.

For higher values of Vds where Vds >= Vgs-Vgs(th), the saturation current lds is now given by (approx.):

 $Ids = u.Cox.W/L . [Vgs-Vgs(th)]^2$ 

#### SUB-THRESHOLD REGION OF OPERATION

Low voltage systems, namely those operating at 5V, 3.3V or less, typically require MOSFETs that have threshold voltage of 1V or less. The threshold, or turn-on, voltage of the MOSFET is a voltage below which the MOSFET conduction channel rapidly turns off. For analog designs, this threshold voltage directly affects the operating signal voltage range and the operating bias current levels.

At or below threshold voltage, an EPAD MOSFET exhibits a turnoff characteristic in an operating region called the subthreshold region. This is when the EPAD MOSFET conduction channel rapidly turns off as a function of decreasing applied gate voltage. The conduction channel induced by the gate voltage on the gate electrode decreases exponentially and causes the drain current to decrease exponentially. However, the conduction channel does not shut off abruptly with decreasing gate voltage, but decreases at a fixed rate of approximately 116 mV per decade of drain current decrease. Thus if the threshold voltage is +0.20V, for example, the drain current is at 1 uA at Vgs = +0.20V. At Vgs = +0.09V, the drain current would decrease to 0.1 uA. Extrapolating from this, the drain current is at 0.01 uA (10 nA) at Vgs = -0.03V, 1 nA at Vgs -0.14V, and so forth. This subthreshold characteristics extends all the way down to current levels below 1 nA and is limited by other currents such as junction leakage currents.

At a drain current to be declared "zero current" by the user, the Vgs voltage at that zero current can now be estimated. Note that using the above example the drain current still hovers around 20 nA when the gate is at zero volt, or ground.

#### LOW POWER AND NANOPOWER

When supply voltages decrease, the power consumption of a given load resistor decreases as the square of the supply voltage. So one of the benefits in reducing supply voltage is to reduce power consumption. While decreasing power supply voltages and power consumption go hand-in-hand with decreasing useful AC bandwidth and at the same time increases noise effects in the circuit, a circuit designer can make the necessary tradeoffs and adjustments in any given circuit design and bias the circuit accordingly.

With EPAD MOSFETs, a circuit that performs a specific function can be designed so that power consumption can be minimized. In some cases, these circuits operate in low power mode where the power consumed is measure in micro-watts. In other cases, power dissipation can be reduced to nano-watt region and still provide a useful and controlled circuit function operation.

#### ZERO TEMPERATURE COEFFICIENT (ZTC) OPERATION

For an EPAD MOSFET in this product family, there exist operating points where the various factors that cause the current to increase as a function of temperature balance out those that cause the current to decrease, thereby canceling each other, and resulting in net temperature coefficient of near zero. One of this temperature stable operating point is obtained by a ZTC voltage bias condition, which is 0.55V above a threshold voltage when Vgs = Vds, resulting in a temperature stable current level of about 68 uA. For other ZTC operating points, see ZTC characteristics.

#### PERFORMANCE CHARACTERISTICS

Performance characteristics of the EPAD MOSFET product family are shown in the following graphs. In general, the threshold voltage shift for each member of the product family causes other affected electrical characteristics to shift with an equivalent linear shift in Vgs(th) bias voltage. This linear shift in Vgs causes the subthreshold I-V curves to shift linearly as well. Accordingly, the subthreshold operating current can be determined by calculating the gate voltage drop relative from its threshold voltage, Vgs(th).

#### RDS(ON) AT VGS=GROUND

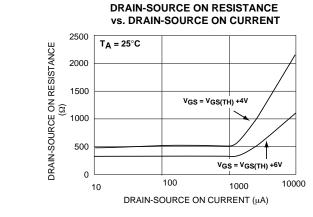
Several of the EPAD MOSFETs produce a fixed resistance when their gate is grounded. For ALD110800, the drain current at Vds = 0.1V is at 1uA at Vgs=0.0V. Thus just by grounding the gate of the ALD110800, a resistor with Rds(on)=~100KOhm is produced. When an ALD114804 gate is grounded, the drain current Ids=18.5 uA@ Vds=0.1V, producing Rds(on)=5.4KOhm. Similarly, ALD114813 and ALD114835 produces 77 uA and 185 uA respectively at Vgs=0.0V, producing Rds(on) values of 1.3 KOhm and 540 Ohm respectively.

#### MATCHING CHARACTERISTICS

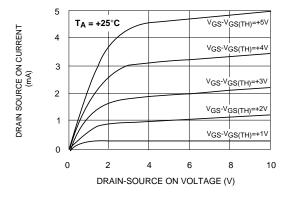
A key benefit of using matched-pair EPAD MOSFET is to maintain temperature tracking. In general, for EPAD MOSFET matched pair devices, one device of the matched pair has gate leakage currents, junction temperature effects, and drain current temperature coefficient as a function of bias voltage that cancel out similar effects of the other device, resulting in a temperature stable circuit. As mentioned earlier, this temperature stability can be further enhanced by biasing the matched-pairs at Zero Tempco (ZTC) point, even though that could require special circuit configuration and power consumption design consideration.

ALD110800/ALD110900/ ALD1108xx/ALD1109xx/ALD1148xx/ALD1149xx

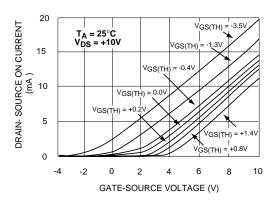
## **TYPICAL PERFORMANCE CHARACTERISTICS**



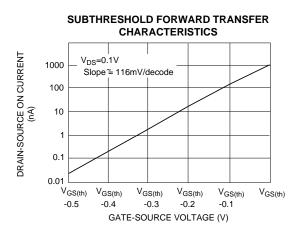
#### **OUTPUT CHARACTERISTICS**



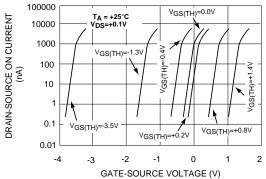
FORWARD TRANSFER CHARACTERISTICS



TRANSCONDUCTANCE vs. AMBIENT TEMPERATURE 2.5 TRANSCONDUCTANCE (mA/V) 2.0 1.5 1.0 0.5 0 -50 -25 25 50 75 100 125 0 AMBIENT TEMPERATURE (°C)



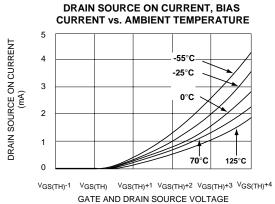
SUBTHRESHOLD FORWARD TRANSFER CHARACTERISTICS



ALD110800/ALD110900/ ALD1108xx/ALD1109xx/ALD1148xx/ALD1149xx

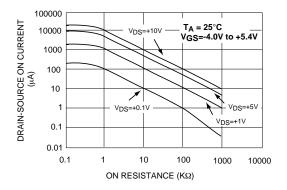
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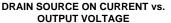
## **TYPICAL PERFORMANCE CHARACTERISTICS**

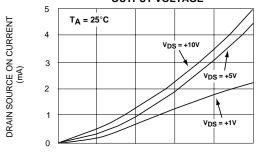


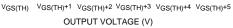
(VGS = VDS) (V)

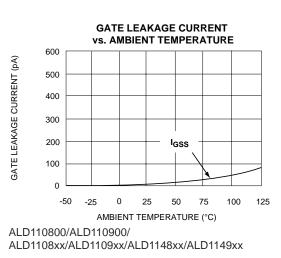
#### DRAIN-SOURCE ON CURRENT vs. ON RESISTANCE

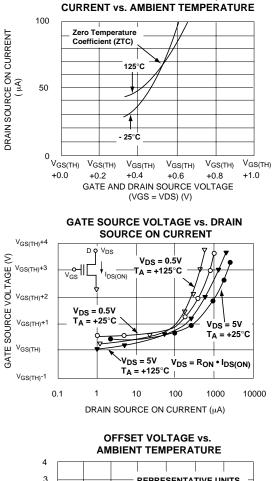




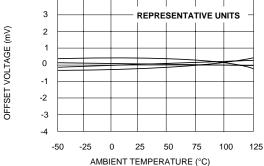




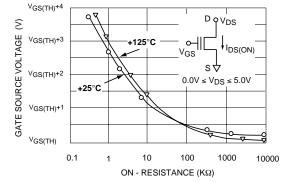




DRAIN SOURCE ON CURRENT, BIAS



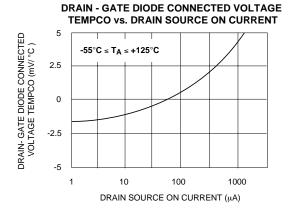
#### GATE SOURCE VOLTAGE vs. ON - RESISTANCE



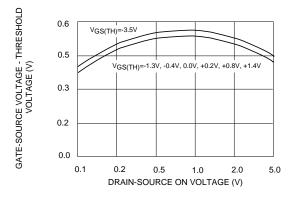
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## **TYPICAL PERFORMANCE CHARACTERISTICS**

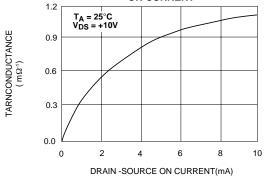
GATE-SOURCE VOLTAGE (V)



#### ZERO TEMPERETURE COEFFICIENT CHARACTERISTIC

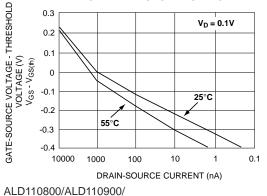






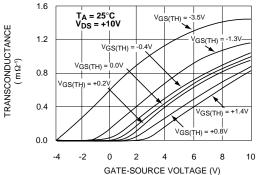
NORMALIZED SUBTHRESHOLD

CHARACTERISTICS RELATIVE GATE THRESHOLD VOLTAGE

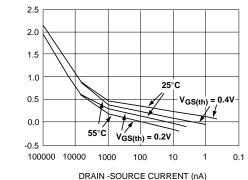


ALD1108xx/ALD1109xx/ALD1148xx/ALD1149xx

## TRANSFER CHARACTERISTICS

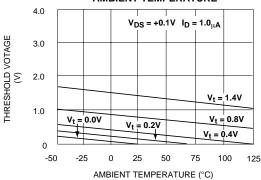


SUBTHRESHOLD CHARACTERISTICS

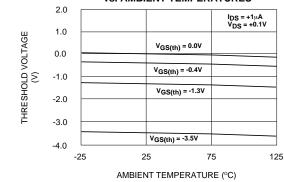


DRAIN -SOURCE CURRENT (nA)

THRESHOLD VOLTAGE vs. AMBIENT TEMPERATURE



#### THRESHOLD VOLTAGES vs. AMBIENT TEMPERATURES



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